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Aluminum-enhanced alkali diffusion from float glass to PVD-sputtered silica thin films

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Abstract

Interdiffusion processes between aluminum enriched PVD-sputtered silica thin films and industrial float sodalime silicate glass substrates are quantitatively studied using SIMS analysis. Heat treatments are performed at temperatures close or above the glass transition temperature of the float glass. Aluminum doping of the film is shown to strongly increase the migration of alkali from the glass substrate to the silica thin film. In particular the final alkali content in the film exhibits a linear scaling with the aluminum concentration. An interdiffusion process is evidenced between bulk alkali ions and protons originating from a significant water content in the as-deposited silica film. Experimental measurements of sodium concentration are shown to be consistent with a simple thermodynamic model based on the equilibration of the activity of sodium between the film and the glass substrate.

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Keywords: Silica thin film, Barrier layer, Alkali-ions migration, Interface diffusion

1 1. Introduction

Industrial glasses coated with thin films are often 2 subjected to thermal treatments, in the framework 3 of a forming process, or in order to enhance specific 4 properties of the glazing, or to improve the me-5 chanical properties of glass. At high temperature 6 close or above the glass temperature of the sub-7 strate, several species diffuse from the substrate to 8 the thin films. For soda-lime float glass, the diffu-9 sion of sodium or other alkali ions is the most signifi-10 cant effect. Alkali diffusion is beneficial for a minor-11 ity of active layers, such as CuGaSe₂ thin film for 12 solar cells, in which controlled diffusion of sodium 13 and potassium has been shown [1] to enhance en-14 ergy conversion. However, sodium alters the elec-15 trical properties of most active layers used in solar 16 cells [2, 3, 4, 5], with dramatic effects such as electri-17 cal shunting caused by the widening of grain bound-18 aries [6]. The diffusion of sodium also decreases the 19

mechanical or electrical properties of low-emissivity coatings [7, 8] used in the building and automotive industry, or of transparent conducting oxide layers used in displays [9].

In order to limit the diffusion of alkali from the glass substrate to the active layers, barrier layers are deposited on the glass surface [2]. Alkali diffusion through a barrier layer has been studied for a variety of compositions, such as silicon nitride [10], silica, alumina [11, 12] or ceria [13], and for different deposition processes such as chemical vapor deposition (CVD) [14, 15], physical vapor deposition (PVD) [7, 8], or sol-gel coating [16, 17]. One of the most common compositions of barrier layers is silica, which is usually doped with aluminum in PVD coaters in order to increase the deposition rate [18]. For non-doped silica thin films, Araujo et al. [19] showed that the chemical potential of sodium in the substrate could be used to predict whether sodium would diffuse from the substrate to the silica layer, or in the other direction in the case of alumina- or boron-rich substrate compositions.

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Table 1: Composition (in weight percent) of the soda-lime glass substrates.

oxides	weight $\%$
SiO_2	73.0
Na_2O	13.5
CaO	10.0
MgO	2.5
Al_2O_3	0.5
K ₂ O	0.1
Other elements	< 0.4

Little experimental data exist on the influence 42 of aluminum on alkali diffusion in silica thin films. 43 Nevertheless, the structure and transport proper-44 ties of bulk aluminosilicate glasses and melts have 45 been studied extensively in the geochemistry com-46 munity [20, 21, 22, 23, 24]. In particular, the struc-47 tural role of sodium changes progressively from net-48 work modifier to charge compensator of Al^{3+} when 49 alumina is added to a silicate melt [25, 21, 26, 27, 50 28]. Therefore, adding aluminum to a sodium sili-51 cate melt with a fixed Na/Si ratio increases its vis-52 cosity, since less sodium is available to depolymerize 53 the silica network [28, 29]. 54

In this work, we study the influence of the alu-55 minum content in silica thin layers on alkali mi-56 gration at temperatures close to the glass tran-57 sition of the glass substrate. In particular, our 58 aim is to identify and characterize the diffusion 59 mechanisms at play at the interface between the 60 glass substrate and the PVD-sputtered silica thin 61 Using Secondary Ion Mass Spectroscopy films. 62 (SIMS), we study experimentally alkali migration 63 at 650°C from soda-lime float glass to PVD-64 sputtered alumina-doped silica layers with differ-65 ent values of aluminum doping. Our experimental 66 results are compared with thermodynamic predic-67 tions. 68

2. Materials and methods 69

2.1. Glass substrates 70

Commercial flat soda-lime glass (Saint-Gobain 71 Planiclear^(R)) with a thickness of 2 mm was used $_{121}$ 72 as substrate. Its composition is given in Table 1. 73 Samples were prepared, cleaned with RBS^{TM} de-74 tergent and rinsed with deionized water before thin 75 film deposition. 76

2.2. Silica thin films deposition

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Pure and aluminum-doped silica layers were deposited by Physical Vapor Deposition (PVD) by cathodic magnetron sputtering at room temperature. Si and Si:Al (8% in weight) targets were used for silica thin films deposition under reactive atmosphere at 2 μ bar in Ar/O₂ plasma. Silica layers containing 0% and $\sim 4\%$ (in weight) of Al₂O₃ were obtained by using a single target and SiO_2 thin films with 0.2%to 1% (in weight) of Al₂O₃ were obtained by cosputtering with the two targets. Therefore, various silica samples with Al₂O₃ concentrations between 0.0 and 4% in weight (corresponding to 0.0 to 2.4%in moles) have been elaborated for this study.

The thickness of the films was measured with surface profilometry (DektakXT, Brucker) or atomic force microscopy (Icon, Brucker). Results for silica layers with thicknesses between 100 nm to 250 nm are presented here. Several deposition chambers were used for this work depending on the size of the samples and the configuration needed (sputtering or co-sputtering).

2.3. Thermal treatments

After deposition on glass, silica thin films were annealed in air at 650°C in an electrical furnace. This temperature is in the range of temperatures used industrially for glass tempering or shaping. One should note that it is higher than the glasstransition temperature (Tg) of the substrate (\sim 550°C). Annealing durations between 5 min and 16 hours were used at this temperature. Samples were directly placed in the furnace prepared at 650°C and quenched in air at the end of the thermal treatment.

2.4. Silica thin films characterization

Quantification of the silica layer was first performed by EPMA (Electron Probe MicroAnalysis) for one thick layer. The measurements were carried out on an SXFive apparatus (CAMECA, France), on samples coated with a thin carbon layer to reduce charging effects. The electrons energies were 5, 10, and 15 keV and the current was 15 nA in order to avoid any sodium diffusion during the acquisition applied on an area of 2 x 40 μ m. The X-rays line selected were the following: Na K α , Si $K\alpha$, Al $K\alpha$ and O $K\alpha$. Due to the larger probed depth (> 1 μ m) of the technique compared to layer thickness $(250 \ nm)$, modeling was performed using Stratagem software (SAMX, France). The latter

Table 2: Concentrations (in weight %) of SiO_2 , Na_2O and Al_2O_3 in a 250 nm thick silica thin film deposited on glass after 1h at 650°C, measured on the same sample by SIMS (in the central zone), EPMA and XPS.

Γ	(weight %)	SiO_2	Na ₂ O	Al_2O_3	Na/Al (atomic)
Γ	SIMS	92.4	3.7	3.9	1.6
	XPS	90.8	4.5	4.7	1.6
	EPMA	89.9	5.2	4.8	1.8

takes into account the in-depth distribution of the
ionization function (called phi(roz)) and based on
the XPP model which is well adapted for stratified
samples [30]. Quantification by EPMA is given in
Table 2.

Furthermore, layer composition for the same 131 sample was estimated by X-ray Photoelectron Spec-132 166 troscopy (XPS). The analyses were performed on ¹⁶⁷ 133 NOVA system (Kratos-GB) equipped with a 168 а 134 monochromatic Al K α X-ray source, operating at 169 135 225W. The collection angle was set at 0° (normal 170 136 detection) in order to maximize the probe depth 171 137 (to 5nm in case of such silica-rich material). Re-172 138 sults obtained are also given in Table 2. 173 139

Since EPMA results consider that the layer com- 174 140 position is homogeneous and XPS only probes the 175 141 layer surface, SIMS depth profiles were carried out 176 142 for depth-resolved measurements of the composi-177 143 tion. Measurements on as-deposited and annealed 178 144 silica layers were performed on a TOF.SIMS 5 179 145 (ION-TOF GmbH, Münster, Germany). The pri- 180 146 mary ions Bi^+ , accelerated at 30 kV were generated ¹⁸¹ 147 by a LMIG (Liquid Metal Ion Gun) operating in 182 148 high-current bunched mode with a beam current of 183 149 3 pA at 16 kHz. The scanned area of 50 x 50 μ m² 184 150 was centered in the middle of the 200 x 200 μm^2 151 185 sputter area performed by the DSC (Dual Source 186 152 Column) source generating Cs⁺. The sputter beam ¹⁸⁷ 153 energy was 2 keV and the applied current was 150 $_{188}$ 154 nA. A usual methodology for non-conductive sam- 189 155 ples was applied: an electron flood gun was used (E 190 156 $\sim 21 \ eV$) in order to reduce charging effects during 191 157 the acquisition in non-interlaced mode (1s sputter-192 158 ing, 0.5s pause, 2.5s acquisition)[31]. 159 193

An example of typical SIMS depth profile is given 194 in Fig. 1. It is generated by the collection of the 195 positive ions coming from the main isotopes elements present within the glass substrate and the 197 layer (i.e.: ${}^{1}H^{+}$, ${}^{30}Si^{+}$, ${}^{23}Na^{+}$, ${}^{40}Ca^{+}$, ${}^{24}Mg^{+}$, 198 165 ${}^{39}K^{+}$, ${}^{27}Al^{+}$, ${}^{120}Sn^{+}$). Cs was selected as abra- 199



Figure 1: Example of a SIMS depth profile (before calibration) of a silica thin film doped with 0.9-wt% Al₂O₃ asdeposited on glass.

sive species because it induces less artifacts due to alkali-ions migration during depth profiling [32, 33]. Only monoatomic ions (as opposed to polyatomic clusters) were followed to generate the composition depth profiles, in order to increase the sensitivity within the silica layer [34]. SIMS values at the extreme surface are affected by transitory effects and should not be interpreted [35].

Depth calibration was obtained from stylus profilometry (Dektak XT, Bruker) performed on two different SIMS craters. The first one stopped at the glass/layer interface determined by the maximum of 120 Sn⁺ signal. Indeed, tin condensates on the atmospheric side of glass during the floating process (see Fig. 1). We assume that tin is totally oxidized after annealing into Sn⁴⁺, which has a negligible mobility [36]. Typical values of the sputtering rate inside the silica layer were between 1.2 and 1.5 nm/s depending on (i) the amount of aluminum, (ii) the deposition conditions and (iii) the thermal treatment. The second crater was stopped deeper in the substrate in order to estimate the sputtering rate for the glass substrate (approximately 1.2 nm/s).

For quantitative depth profiling with SIMS (except for hydrogen), the use of relative sensitivity factors (RSF) is necessary for the conversion of intensities into concentrations [37, 14]. The secondary ion yields of SIMS can be strongly dependent on the composition of the matrix. However, according to the author's experience, we made the assumption that matrix effects are comparable in the dense silica thin films and the soda-lime glass substrate. Therefore the determination of relative sensitivity factors has been made from the compo-

sition of the glass substrate measured by wet chem-200 istry (cf Table 1). Results of the average values 201 of SiO₂, Na₂O and Al₂O₃ content over a central 202 zone (in order to avoid SIMS artifacts) are given 203 in Table 2. Values obtained with these three tech-204 niques converge with differences less than $\pm 20\%$. 205 Consequently, our assumption for SIMS quantifica-206 tion appears to be relevant. 207

Finally, hydrogen amount was evaluated by Elas-208 tic Recoil Detection Analysis (ERDA). The experi-209 ment was carried out on the 2.1MeV Van-der-Graff 210 accelerator AIFIRA (CENBG-France). The ⁴He⁺ 211 ions produced, impinged the sample surface at graz-212 ing incidence and the hydrogen atoms were col-213 lected through a filter (in order to stop He ions). 214 The spectra were processed using SIMRA software. 215 SIMS and ERDA results concerning hydrogen will 216 be discussed in Section 4.2. 217

218 3. Results

Typical quantified SIMS depth profiles inside silica thin films deposited on glass are presented on Fig. 2, before and after thermal treatment.

As shown on Fig. 2a and 2c, deposition of silica 222 thin film with our PVD protocol allows us to ob-223 tain pure and aluminum-doped silica layers without 224 contamination by the various oxides contained in 225 the glass substrate. Nevertheless, after annealing 226 for one hour at 650°C pure or alumina-doped silica 227 layers (Figs. 2b and 2d), we observe the migration 228 of sodium and potassium from the glass substrate to 229 the silica layer. On the other hand, alkaline-earth 230 elements such as calcium and magnesium are not 231 measured in significant amounts. Interestingly, the 232 concentration of alkali oxides (both Na₂O and K₂O) 233 after thermal treatment is substantially higher for 234 an Al₂O₃-doped silica layer (Fig. 2d) than for a pure 235 silica layer (Fig 2b). 236

In order to study the relationship between alu-237 minum doping and alkali migration, we extracted 238 the average value of the Na₂O and K₂O content (av-239 eraged over a central zone in order to avoid SIMS 240 artifacts at interfaces) in doped and pure silica lay-241 ers. Na₂O and K₂O contents are plotted respec-242 tively in Fig. 3a and Fig. 3b as a function of Al_2O_3 243 content, for different annealing durations at 650°C. 244 We observe a clear affine relation between Al_2O_3 245 and alkali oxides concentrations (mol %), with a 246 best least-square fit given by: 247

$$_{248} \qquad C_{\text{Na}_2\text{O}} = 1.47 C_{\text{Al}_2\text{O}_3} + 0.22 \tag{1}$$



Figure 2: SIMS profiles of silica thin films deposited on glass: a- pure silica layer before annealing, b- pure silica layer after 1h-annealing at 650° C, c- 4-wt% Al₂O₃-doped silica layer before annealing, d- 4-wt% Al₂O₃-doped silica layer after 1h-annealing at 650° C.



Figure 3: Na₂O content (a) and K₂O content (b) in silica layers after annealing at 650°C for different Al₂O₃ contents ²⁶⁸ and annealing durations.



Figure 4: Na₂O SIMS profiles after diffusion in silica layers for short annealing durations at 650°C, for a 4-wt% Al₂O₃doping of the silica layer.

$$C_{\rm K_2O} = 0.066 \, C_{\rm Al_2O_2} + 0.005 \tag{2}$$

The agreement between experimental data and the affine law is as good for both alkali species. However, the K_2O content is very low (always < $0.2 \mod \%$), while the Na₂O content is larger than the Al_2O_3 content, with ~1.5 times more sodium atoms than aluminum atoms in silica after the thermal treatment at 650°C. Note that the atomic ratio between sodium and potassium is ~ 25 , while it is 200 in the substrate.

Fig. 3 also shows that, for a given aluminum content, Na₂O and K₂O concentrations saturate after an annealing time of about 15 minutes. For shorter annealing durations, Fig. 4 shows that the sodium concentration increases gradually from the interface with glass to the interface with air. After 15 minutes at 650°C, a uniform sodium concentration profile is observed throughout the layer.

At longer times, the migration of alkali is followed by a dissolution of the silica layer into the substrate, as shown in Fig. 5, where silica profiles are plotted for annealing durations from 15 to 240 minutes. The interface between the silica layer and the glass is marked by a sharp drop of the silica content. The interface shifts gradually from its initial position (green dotted line, which is detected as the position of the Sn^+ peak), toward the upper surface of the film. This shift denotes a dissolution of the silica layer, due to interdiffusion between the high-silica layer and the substrate with a lower sil-

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Figure 5: SiO₂ SIMS profiles of (a) a 150 nm pure silica thin film, and (b) a 150 nm Al₂O₃-doped silica thin film for various annealing durations at 650°C. Interface before annealing (vertical green dotted line) is followed by the maximal value of the Sn⁺ peak during SIMS analysis

ica content. For pure silica lavers (with 0.2 mol 330 279 % of Na₂O), the interface is simply translated (see $_{331}$ 280 Fig. 5b), as for the dissolution of a mineral. For 332 281 the 4-wt% Al₂O₃-doped silica layer, the interface 333 282 remains very sharp on the silica layer side, while it 334 283 becomes broader on the substrate side, indicating a 335 284 more pronounced interdiffusion between substrate 336 285 and layer. Also note that the dissolution is faster 337 286 for the doped layer than for the pure-silica layer, 338 287 since the distance between the initial and the new $_{339}$ 288 interface grows approximatively twice faster for the 340 289 Al-doped layer. 290

This slow process of dissolution of the silica thin 342 291 film into the glass substrate and its dependence 343 292 on the aluminum-doping of the layer will be ad-293 dressed in greater details elsewhere. In the follow-294 ing section, we focus the discussion on the effect 345 295 of aluminum-doping on the migration of alkali ions 346 296 from the glass substrate to the silica layer. 297

4. Discussion 298

4.1. Mechanism of alkali migration

Our experiments at 650°C demonstrate that alkali ions such as Na⁺ and K⁺ diffuse from glass to silica thin films. As shown in Figs. 3 and 4, alkali ions concentrations are already equilibrated in silica layers after a few minutes at 650°C independently of the Al_2O_3 content, so that the diffusion length is larger than the 150-nm-width of the silica layer. Previous studies of sodium diffusion in bulk silica glass found diffusivities between 3.10^{-15} and $3.10^{-11} \text{ m}^2 \text{.s}^{-1} [2, 38, 39, 40]$. The discrepancy between diffusivity values in different experiments was attributed to the variable hydroxyl content of the silica glasses [39], depending on its elaboration process. The presence of H⁺ in silica was found to decrease the mobility of Na⁺, an illustration of the mixed-alkali effect [41]. Even the smallest diffusivity value obtained in previous studies (3.10^{-15}) gives a diffusion distance of 1 micron in 10 minutes, that is a diffusion length greater than the width of the silica layer. Therefore, constant sodium profiles after 15 minutes at 650°C are consistent with literature values for sodium diffusivity.

For bulk aluminosilicate glasses containing Na₂O and/or K₂O, interdiffusion between melts of differing alkali concentrations is mostly governed by the exchange of alkali ions with SiO_2 [42, 43, 44, 45]. Such exchanges, if present, would result in a variation of the Si/Al ratio before and after sodium migration. However, during alkali-ions migration, we observe that the atomic ratio Si/Al in the silica layer remains constant, as shown in the SiO₂-Al₂O₃-Na₂O phase diagram in Fig. 6 (red dotted arrows). Therefore, the migration of sodium and potassium corresponds to a dilution of the initial composition of the layer, and not to a counter flux of alkali and Si or Al.

Nevertheless, electro-neutrality requires a net flux of another charged species to compensate the charge of additional alkali. Previous studies in barrier layers [2, 19] suggested that a counter-flux of protons enables sodium migration into silica. The influence of water concentration on sodium migration had also been studied in bulk silica [46, 39]. The influence of water is discussed in more details in the next paragraphs.

4.2. Interdiffusion between protons and alkali ions

Water is one of the most common important impurity found in PVD sputtered thin films. It's ori-

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Figure 6: Zoom of the phase diagram in the ternary system $SiO_2-Al_2O_3-Na_2O$ between 92 and 100% SiO_2 in mol %. Empty circles correspond to silica thin films before annealing and filled circles to silica thin films after sodium migration. Red dotted arrows correspond to a constant Si/Al atomic ratio.

Table 3: Hydrogen content in silica films as measured by 366 ERDA for a pure silica layer or a 2.4-mol% Al₂O₃-doped 367 silica layer. Analyses are performed on samples before and 368 after thermal treatments 30 minutes at 650° C. 369

H content	Before	After
$\pmod{\%}$	annealing	annealing
pure silica	0.40~%	< 0.1 ~%
	$\approx 6000 \text{ ppm H}_2\text{O}$	
Al-doped silica	0.38~%	$< 0.1 \ \%$
	$\approx 6000 \text{ ppm H}_2\text{O}$	

gin could be outgassing phenomenon of the depo-348 sition chamber walls during the process and sur-349 face adsorption during storage due to the porosity 379 350 of the layers. Table 3 report ERDA measurements 380 351 that could be performed on two samples (one pure-352 silica layer and one 2.4-mol% Al₂O₃-doped layer) 353 before and after thermal annealing. They first show 383 354 that significant hydrogen contents (of the order of 384 355 half percent) can be found in the deposited silica 385 356 or aluminum-doped silica thin films. Interestingly, 386 357 this hydrogen content shows a sharp decrease after 387 358 thermal treatment. 359

The loss of H upon annealing is clearly consistent 389 360 with a scenario of interdiffusion between hydrogens 390 361 of the layer and alkali ions of the glass substrate. In 391 362 order to test this hypothesis further we performed 392 363 SIMS measurements on samples annealed at a lower 393 364 temperature, T=550°C. The slowing of the dynam-365



Figure 7: Na⁺ and H⁺ SIMS profiles after 5 and 15 minutes at 550°C, for a 4-wt% Al_2O_3 -doping of the silica layer.

ics thus allowed us to observe earlier steps of the diffusion process, i.e. before saturation of the alkali content in the film. We show in Fig. 7 SIMS profiles in a 4-wt% Al₂O₃-doped silica thin film of $\mathrm{H^{+}}$ and $\mathrm{Na^{+}}$ ions after 5 min. and 15 min. of the rmal treatment at 550°C, respectively. Although not quantitative, these profiles show a clear trend: an interdiffusion front of the two species moving from the glass substrate interface toward the surface of the thin film.

4.3. Equilibrium sodium concentration in silica layer

Since alkali concentration is constant after 15 minutes in the silica layers, alkali species are at thermodynamic equilibrium and should have a similar chemical potential in the substrate and in the silica layer. Using the software $Factsage^{(\mathbb{R})}$ with the FT oxides database and especially the FT oxid-SLAGA module (A-Slag-liq all oxides) developed for silicate systems ([47, 48, 49, 50, 51]), we computed the activity of sodium in the substrate and in the silica layer, for various aluminum and sodium concentrations. In order to stress the crucial effect of the water content in silica films on the alkali diffusion from the glass substrate, we present below results obtained in absence and in presence of water in the films.

The activity of sodium at 650°C as a function of sodium concentration in a dry silica layer is repre-

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sented in Fig. 8a, for three different aluminum dop- 446 395 ing contents. We observe that increasing the alu- 447 396 minum content decreases the activity of sodium, a 448 397 result that has been obtained experimentally in the 449 398 literature [52] and that is explained by the smaller $_{450}$ 399 sodium content in network-modifying role. A sharp 451 400 increase of sodium activity occurs when the mo-401 452 lar concentration of sodium equates the one of alu-453 402 minum. Qualitatively, this corresponds to the con-454 403 centration at which sodium ions charge-compensate 455 404 all aluminum tetrahedral units. Therefore, the ac- 456 405 tivity of sodium in the layer depends strongly on 457 406 the aluminum content. In Fig. 8a, the activity of 458 407 sodium in the glass substrate is represented as a red 459 408 dotted line. 409

We define the theoretical sodium equilibrium 410 concentration as the concentration at which chemi-411 cal potentials are the same in the substrate and the 412 silica layer. The sodium equilibrium concentration 413 is plotted in Fig. 8c (orange line) as a function of 414 aluminum content of the silica layer. We observe 415 an affine (almost linear) relation as in our exper-416 iments, but with a different Na/Al atomic ratio: 417 thermodynamic calculations predict a ratio close to 418 one (which amounts to compensating all aluminum 419 tetrahedra), whereas a ratio of 1.5 is observed in 420 our experiments. This means that (in experiments) 421 1/3 of sodium ions in the silica layer are not charge 422 compensators of aluminum tetrahedra, but network 423 modifiers bound to non-bridging oxygens. 424

However, it is known [53, 54, 55, 56] that the pres-425 474 ence of water modifies the structure of aluminosili-475 426 cate glasses and melts, hence the activity of sodium 476 427 in these materials. This strong effect is illustrated 477 428 in Fig. 8b, where we plotted the activity of sodium 478 429 in a silica layer as in Fig. 8a, for a layer composi-479 430 tion including both the aluminum doping and the 431 480 presence of water (we arbitrarily chose 6000 ppm of 432 481 water as measured by ERDA in a Al₂O₃-doped sil-482 433 ica layer - 2.4 mol % - cf Table 3, but we found that 483 434 the value of sodium activity has a very weak depen- 484 435 dence with water between 100 ppm to 20000 ppm). 485 436 Calculations of sodium activities in presence of wa-437 ter are also performed using Factsage ^(B) with the 487 438 FT oxides database but with the FT oxid-SLAGE 488 439 module (E-Slag-liq with H2O/OH) which can take 489 440 into account interactions of water with the silicate 490 441 network [57, 58]. Comparing Fig. 8a and Fig. 8b 491 442 shows that: (i) for a pure silica layer, the activ-492 443 ity of sodium does not change with or without wa-493 444 ter, (ii) but for an aluminum-doped silica layer, the 445 494

activity of sodium changes drastically when water is added. Indeed, the evolution of sodium activity is more gradual in the presence of water, suggesting that water-induced network depolymerization [53, 54] results in a greater diversity of sites for sodium. The sodium equilibrium concentration in the presence of water is plotted in Fig. 8c (violet line). We observe an affine scaling with aluminum content as in water-free layers, but with a greater slope. A least-square fit gives a value of 1.46 for the Na/Al ratio, which is very close to the experimental value (1.47) of Fig. 3a. Therefore, a quantitative prediction of sodium content in the layer can be obtained by balancing sodium activities in substrate and layer, if the presence of some water in the layer is taken into account.

5. Conclusions

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In this work we have studied the diffusion processes occurring in silica-based thin films deposited on float glass during thermal treatments above the glass-transition temperature of the glass substrate. Using SIMS analysis, we have quantified the migration of sodium and potassium in silica thin films and shown that their concentration reaches a saturation value after only 15 minutes of annealing at 650°C. The aluminum doping of the silica film has been shown to strongly enhance (with a linear scaling) the diffusion of alkali ions from the glass substrate.

The presence of water in the as-deposited silica films (validated by ERDA measurements) has appeared to be a key element of understanding of this phenomenon. First we could identify an interdiffusion process between the protons of the film and the sodium ions of the glass substrate. Then, taking water into account was shown to drastically modify the thermodynamic activity of sodium in the layer and thus its final equilibrium concentration.

In particular the latter exceeds the aluminum concentration of the thin film. The sodium ions in the aluminum-doped silica layer thus exist not only as charge compensators of the aluminum ions inserted in the silica network but also as network modifiers. As illustrated in Fig. 5, this depolymerization effect of aluminum on the silica network is likely to strongly affect the slower homogenization process (thin film dissolution) occurring at long times and will be addressed in more detailed in a future study.



Figure 8: Energetics of sodium - (a) Na₂O activity in sil-541 ica layer at 650°C as a function of Na₂O concentration, for 542 different aluminum doping, and for free sodium atoms (i.e., 543 network modifiers and not charge compensators). Calcula-544 tions are made with Factsage[®] software, using the FT oxides 545 546 database. The red dotted line marks the value of Na₂O activ-547 ity at 650° C in the float glass substrate. (b) Same as (a), for 548 silica layers containing 6000ppm of water. (c) Equilibrium sodium concentration in the silica layer as a function of alu-549 550 minum doping, for dry layers (orange) and water-containing 551 layers (violet). 552

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References

- S. Ishizuka, A. Yamada, P. J. Fons, H. Shibata, S. Niki, Interfacial alkali diffusion control in chalcopyrite thinfilm solar cells, ACS Appl. Mater. Inter. 6 (16) (2014) 14123–30. doi:10.1021/am503480m.
- [2] N. Janke, O. Grassme, R. Weimann, Alkali ion migration control from flat glass substrates, Glass Sci. Tech. 73 (2000) 143–155.
- [3] J. H. Scofield, S. Asher, D. Albin, J. Tuttle, M. Contreras, D. Niles, R. Reedy, A. Tennant, R. Noufi, Sodium diffusion, selenization, and microstructural effects associated with various molybdenum back contact layers for CIS-based solar cells, in: 24th IEEE Photovoltaic Specialists Conference, Vol. 1, pp. 164–167. doi:10.1109/wcpec.1994.519833.
- [4] K. Durose, M. A. Cousins, D. S. Boyle, J. Beier, D. Bonnet, Grain boundaries and impurities in CdTe/CdS solar cells, Thin Solid Films 403-404 (2002) 396-404. doi:10.1016/s0040-6090(01)01518-8.
- [5] M. Emziane, K. Durose, D. P. Halliday, N. Romeo, A. Bosio, The distribution of impurities in the interfaces and window layers of thin-film solar cells, J. Appl. Phys. 97 (11) (2005) 114910. doi:10.1063/1.1921344.
- [6] L. Kranz, J. Perrenoud, F. Pianezzi, C. Gretener, P. Rossbach, S. Buecheler, A. Tiwari, Effect of sodium on recrystallization and photovoltaic properties of CdTe solar cells, Sol. Energ. Mat. Sol. C. 105 (2012) 213–219. doi:10.1016/j.solmat.2012.06.019.
- [7] J. Kulczyk-Malecka, P. J. Kelly, G. West, G. C. B. Clarke, J. A. Ridealgh, Investigations of diffusion behaviour in Al-doped zinc oxide and zinc stannate coatings, Thin Solid Films 520 (5) (2011) 1368–1374. doi: 10.1016/j.tsf.2011.08.076.
- [8] J. Kulczyk-Malecka, P. J. Kelly, G. West, G. C. B. Clarke, J. A. Ridealgh, Diffusion studies in magnetron sputter deposited silicon nitride films, Surf. Coat. Tech. 255 (2014) 37-42. doi:10.1016/j.surfcoat.2013.11. 027.
- [9] J.-M. Lee, B.-H. Choi, M.-J. Ji, Y.-T. An, J.-H. Park, J.-H. Kwon, B.-K. Ju, Effect of barrier layers on the properties of indium tin oxide thin films on soda lime glass substrates, Thin Solid Films 517 (2009) 4074– 4077. doi:10.1016/j.tsf.2009.01.149.
- [10] M. N. Ghazzal, E. Aubry, N. Chaoui, D. Robert, Effect of SiN_x diffusion barrier thickness on the structural properties and photocatalytic activity of TiO₂ films obtained by sol-gel dip coating and reactive magnetron

- sputtering, Beilstein J. Nanotech. 6 (2015) 2039-45. 619 554 doi:10.3762/bjnano.6.207. 555
- [11] F. P. Fehlner, N. J. Binkowski, K. R. Salisbury, L. But- 621 556 ton, Alumina barrier layers on LCD glass, J. Non-Cryst. 557 622 558 Solids 195 (1996) 89-94. doi:10.1016/0022-3093(95) 623 00473-4 559 624
- [12] F. P. Fehlner, Thin films on glass for liquid crystal dis-560 625 plays, J. Non-Cryst. Solids 218 (1997) 360-367. doi: 561 626 10.1016/S0022-3093(97)00243-3. 562 627
- S. Sonderby, P. L. Popa, J. Lu, B. H. Christensen, 628 [13]563 K. P. Almtoft, L. P. Nielsen, P. Eklund, Strontium diffu-629 564 sion in magnetron sputtered gadolinia-doped ceria thin 630 565 film barrier coatings for solid oxide fuel cells, Adv. En-566 631 ergy Mater. 3 (7) (2013) 923-929. doi:10.1002/aenm. 632 567 201300003 568
- S. Dreer, P. Wilhartitz, K. Piplits, K. Mayerhofer, 634 569 [14]J. Foisner, H. Hutter, Quantitative SIMS depth pro-570 635 571 filing of diffusion barrier gate-oxynitride structures in 636 TFT-LCDs, Anal. Bioanal. Chem. 379 (2004) 599-604. 637 572 doi:10.1007/s00216-003-2468-y. 573 638
- [15]J. W. Osenbach, S. S. Voris, Sodium diffusion in 574 639 plasma-deposited amorphous oxygen-doped silicon ni- 640 575 tride (a-SiON:H) films, J. Appl. Phys. 63 (1988) 4494. 576 641 577 doi:10.1063/1.340144.
- F. Guanghui, D. Jiafeng, P. Donghui, H. Ouli, The mi-[16]578 643 579 gration of alkali ions from glass substrates coated with 644 sol-gel barrier films, J. Non-Cryst. Solids 112 (1989) 580 581 454457.
- [17] B. M. Davies, K. H. Pannell, S. P. Albright, Diffusion 582 647 barrier of sol-gel derived silica for sprayed tin oxide film 648 583 on soda-lime glass, J. Mater. Res. 9 (01) (2011) 226–228. 584 649 doi:10.1557/jmr.1994.0226. 585
- [18] J. Wolfe, C. Boehmler, J. Hofmann, Method for 586 651 587 coating substrates with silicon based compounds 652 EP0502068B1 (04 1995). 588 653
- [19] R. J. Araujo, F. P. Fehlner, Sodium redistribution be-589 654 590 tween oxide phases, J. Non-Cryst. Solids 197 (1996) 655 154-163. doi:10.1016/0022-3093(95)00632-X. 591
- S. K. Lee, J. F. Stebbins, The structure of aluminosil-592 [20]657 icate glasses: High-resolution ¹⁷O and ²⁷Al MAS and 593 658 3QMAS NMR study, J. Phys. Chem. B 104 (17) (2000) 594 659 4091 - 4100. 595 660
- [21]S. K. Lee, J. F. Stebbins, The distribution of sodium 596 661 ions in aluminosilicate glasses: a high-field Na-23 MAS 597 662 and 3Q MAS NMR study, Geochim. Cosmochim. Ac. 598 663 67 (9) (2003) 1699-1709. 599 664
- [22] S. K. Lee, J. F. Stebbins, Effects of the degree of poly-600 665 merization on the structure of sodium silicate and alu-601 minosilicate glasses and melts: An ¹⁷O NMR study, 602 667 Geochim. Cosmochim. Ac. 73 (4) (2009) 1109–1119. 603
- Y. Zhang, H. Ni, Y. Chen, Diffusion data in silicate [23]604 669 melts, Rev. Mineral, Geochem, 72 (1) (2010) 311-408. 605
- [24]Y. Liang, Multicomponent diffusion in molten silicates: 606 671 theory, experiments, and geological applications, Re-607 672 views in Mineralogy and Geochemistry 72 (1) (2010) 608 673 609 409 - 446.
- [25]A. M. George, J. F. Stebbins, Dynamics of Na in sodium 610 675 aluminosilicate glasses and liquids, Phys. Chem. Miner. 611 676 23 (8) (1996) 526-534. 612
- J. R. Allwardt, B. T. Poe, J. F. Stebbins, The effect of 678 [26]613 fictive temperature on Al coordination in high-pressure 679 614 (10 GPa) sodium aluminosilicate glasses, Am. Mineral. 680 615 90 (8-9) (2005) 1453-1457. 616 681
- 617 [27]Y. Xiang, J. Du, M. M. Smedskjaer, J. C. Mauro, Struc-682 ture and properties of sodium aluminosilicate glasses 683 618

from molecular dynamics simulations, J. Chem. Phys. 139 (4) (2013) 044507.

- C. Le Losq, D. R. Neuville, P. Florian, G. S. Henderson, [28]D. Massiot, The role of Al^{3+} on rheology and structural changes in sodium silicate and aluminosilicate glasses and melts, Geochim. Cosmochim. Ac. 126 (2014) 495-517. doi:10.1016/j.gca.2013.11.010.
- M. J. Toplis, D. B. Dingwell, T. Lenci, Peraluminous [29]viscosity maxima in Na₂O-Al₂O₃-SiO₂ liquids: The role of triclusters in tectosilicate melts, Geochim. Cosmochim. Ac. 61 (13) (1997) 2605-2612.
- [30] J. L. Pouchou, F. Pichoir, Analyse d'échantillons stratifiés à la microsonde électronique, Le Journal de Physique Colloques 45 (C2) (1984) 47–50. doi:10. 1051/jphyscol:1984212.
- [31] Z. Wang, K. Jin, Y. Zhang, F. Wang, Z. Zhu, ToF-SIMS depth profiling of insulating samples, interlaced mode or non-interlaced mode?, Surf. Interface Anal. 46 (S1) (2014) 257-260. doi:10.1002/sia.5419.
- [32] Y. Yamamoto, N. Shimodaira, SIMS depth profile analysis of sodium in silicon dioxide, Appl. Surf. Sci. 255 (4) (2008) 860-862. doi:10.1016/j.apsusc.2008.05.069.
- [33] S. Krivec, T. Detzel, M. Buchmavr, H. Hutter, On the temperature dependence of Na migration in thin SiO_2 films during ToF-SIMS O_2^+ depth profiling, Appl. Surf. Sci. 257 (1) (2010) 25–32. doi:10.1016/j.apsusc. 2010.06.019
- B. Saha, P. Chakraborty, MCs_n^+ -SIMS: An innovative [34]approach for direct compositional analysis of materials without standards, Energy Proced. 41 (2013) 80-109. doi:10.1016/j.egypro.2013.09.009.
- U. Hoffmann, G. Heide, G. H. Frischat, Reactions be-[35]tween solgel coatings and some technical glass substrates during consolidation, Journal of Non-Crystalline Solids 351 (43-45) (2005) 3562-3569. doi:10.1016/j. jnoncrysol.2005.08.032.
- [36]G. Heide, C. Muller-Fildebrandt, D. Moseler, G. Frischat, W. Meisel, A. Maldener, A. Zouine-Thimm, F. Rauch, Tin in float glass: A diffusionreaction model based on surface analysis explains the tin hump, Glass Science and Technology - Glastechnische Berichte 73 (2000) 321-330.
- [37]U. Breuer, H. Holzbrecher, M. Gastel, J. S. Becker, H.-J. Dietze, Comparative studies of MCs⁺-SIMS and e⁻beam SNMS for quantitative analysis of bulk materials and layered structures, Fresen. J. Anal. Chem. 353 (3) (1995) 372-377. doi:10.1007/bf00322072.
- G. H. Frischat, Sodium diffusion in SiO₂ glass, J. Am. [38]Ceramic Soc. 51 (9) (1968) 528-530.
- L. Tian, R. Dieckmann, C.-Y. Hui, Y.-Y. Lin, J. G. [39] Couillard, Effect of water incorporation on the diffusion of sodium in type I silica glass, J. Non-Cryst. Solids 286 (3) (2001) 146-161.
- [40] L. Tian, R. Dieckmann, Incorporation of water into glasses and its influence on the diffusion of cations, including the creation of diffusion barriers, J. Non-Cryst. Solids 352 (6) (2006) 679-689.
- [41]J. Isard, The mixed alkali effect in glass, J. Non-Cryst. Solids 1 (3) (1969) 235-261.
- S. Chakraborty, D. B. Dingwell, D. C. Rubie, Multi-[42]component diffusion in ternary silicate melts in the system K₂O-Al₂O₃-SiO₂: I. experimental measurements, Geochim. Cosmochim. Ac. 59 (2) (1995) 255-264. doi: 10.1016/0016-7037(94)00283-r.
- [43]S. Chakraborty, D. B. Dingwell, D. C. Rubie, Multicom-

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- ponent diffusion in ternary silicate melts in the system 749 K₂O-Al₂O₃-SiO₂: II. mechanisms, systematics, and ge-750 ological applications, Geochim. Cosmochim. Ac. 59 (2) 751 (1995) 265-277. doi:10.1016/0016-7037(95)00284-7.
- [44]J. E. Mungall, C. Romano, D. B. Dingwell, Multicomponent diffusion in the molten system K₂O-Na₂O-
- 689 Al₂O₃-SiO₂-H₂O, Am. Mineral. 83 (1998) 685–699. 690 doi:10.2138/am-1998-7-802. 691
- [45] C. Guo, Y. Zhang, Multicomponent diffusion in sil-692 icate melts: SiO₂-TiO₂-Al₂O₃-MgO-CaO-Na₂O-K₂O 693 system, Geochim. Cosmochim. Ac. 195 (2016) 126-141. 694
- [46]J. Mecha, J. Steinmann, et al., Mobility of sodium ions 695 in silica glass of different OH content, J. Am. Ceramic 696 Soc. 62 (7-8) (1979) 343-346. 697
- [47] C. W. Bale, P. Chartrand, S. A. Degterov, G. Eriks-698 son, K. Hack, R. Ben Mahfoud, J. Melanon, A. D. Pelton, S. Petersen, Factsage thermochemical software 700 and databases, Calphad 26 (2) (2002) 189-228. doi: 10.1016/s0364-5916(02)00035-4.
- C. W. Bale, E. Blisle, P. Chartrand, S. A. Decterov, 703 [48]G. Eriksson, K. Hack, I. H. Jung, Y. B. Kang, 704 J. Melanon, A. D. Pelton, C. Robelin, S. Petersen, 705 Factsage thermochemical software and databases re-706 707 cent developments, Calphad 33 (2) (2009) 295-311. doi:10.1016/j.calphad.2008.09.009. 708
- [49]G. Eriksson, A. Pelton, Critical evaluation and opti-709 mization of the thermodynamic properties and phase 710 diagrams of the CaO-Al $_2O_3$, Al $_2O_3$ -SiO $_2$ and CaO-711 Al₂O₃-SiO₂ systems, Metall. Trans. 24B (1993) 807-712 816. 713
- [50]G. Eriksson, P. Wu, A. Pelton, Critical evaluation 714 and optimization of the thermodynamic properties and 715 phase diagrams of the MgO-Al₂O₃, MnO-Al₂O₃, FeO-716 717 Al₂O₃, Na₂O-Al₂O₃ and K₂O-Al₂O₃ systems, Calphad Journal 17 (1993) 189-206. 718
- [51]P. Wu, G. Eriksson, A. Pelton, Critical evaluation 719 720 and optimization of the thermodynamic properties and phase diagrams of the Na₂O-SiO₂ and K₂O-SiO₂ sys-721 tems, J. Am. Ceram. Soc. 76 (1993) 2059-2064. 722
- S. Abdelouhab, R. Podor, C. Rapin, M. Toplis, 723 [52]P. Berthod, M. Vilasi, Determination of Na₂O activities 724 in silicate melts by EMF measurements, J. Non-Cryst. 725 Solids 354 (26) (2008) 3001-3011. 726
- Q. Zeng, H. Nekvasil, C. P. Grey, In support of a de-[53]727 polymerization model for water in sodium aluminosil-728 icate glasses:: Information from NMR spectroscopy, 729 Geochim. Cosmochim. Ac. 64 (5) (2000) 883-896. 730
- [54] E. Robert, A. Whittington, F. Fayon, M. Picha-731 vant, D. Massiot, Structural characterization of water-732 733 bearing silicate and aluminosilicate glasses by highresolution solid-state NMR, Chem. Geol. 174 (1) (2001) 734 291 - 305.735
- [55] X. Xue, M. Kanzaki, Structure of hydrous aluminosili-736 cate glasses along the diopside-anorthite join: A com-737 prehensive one-and two-dimensional ¹H and ²⁷Al NMR 738 study, Geochim. Cosmochim. Ac. 72 (9) (2008) 2331-739 2348.740
- 741 [56]W. J. Malfait, X. Xue, The nature of hydroxyl groups in aluminosilicate glasses: Quantifying Si-OH and Al-OH 742 abundances along the SiO_2 -NaAlSiO₄ join by ¹H, ²⁷Al-743 ¹H and ²⁹Si-¹H NMR spectroscopy, Geochim. Cos-744 mochim. Ac. 74 (2) (2010) 719-737. 745
- I.-H. Jung, Thermodynamic modeling of gas solubility [57]746 747 in molten Slags (I) - Water, ISIJ Int 46 (2006) 1587-1593748

[58] A. Pelton, Thermodynamic calculation of gas solubilities in oxide melts and glasses, Glastechnische Berichte 72 (1999) 214-226.